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FDS4435BZ_F085 P-Channel PowerTrench[®] MOSFET -30V, -8.8A, 20mΩ

Features

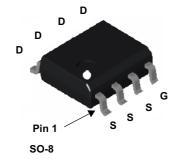
- Max $r_{DS(on)}$ = 20m Ω at V_{GS} = -10V, I_D = -8.8A
- Max $r_{DS(on)}$ = 35m Ω at V_{GS} = -4.5V, I_D = -6.7A
- Extended V_{GSS} range (-25V) for battery applications
- HBM ESD protection level of ±3.8KV typical (note 3)
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability
- Termination is Lead-free and RoHS compliant
- Qualified to AEC Q101

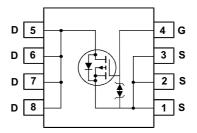




General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter Drain to Source Voltage			Ratings	Units V
V _{DS}				-30	
V _{GS}	Gate to Source Voltage			±25	V
I _D	Drain Current -Continuous	T _A = 25°C	(Note 1a)	-8.8	
	-Pulsed			-50	Α
P _D	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	14/
	Power Dissipation	T _A = 25°C	(Note 1b)	1.0	W
E _{AS}	Single Pulse Avalanche Energy		(Note 4)	24	mJ
T _J , T _{STG}	Operating and Storage Junction Temperation	ature Range		-55 to +150	°C

Thermal Characteristics

R_6	JC	Thermal Resistance, Junction to Case	25	°C/W	
R_{6}	ЭJA	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS4435BZ	FDS4435BZ_F085	SO-8	13"	12mm	2500units

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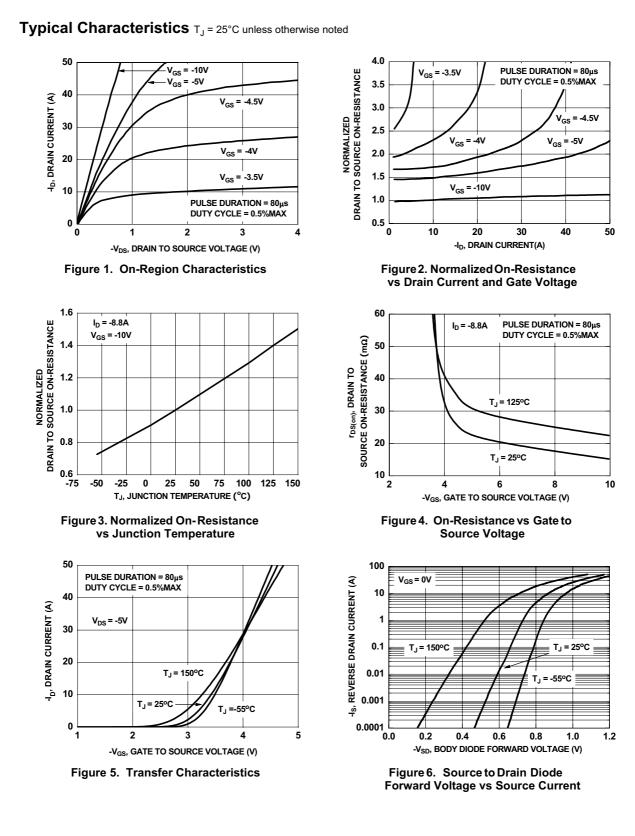
Off Charac BV _{DSS} <u>ABV_{DSS}</u> AT _J I _{DSS} I _{GSS}			Min	Тур	Max	Units
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$						
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Drain to Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0 V$	-30			V
ΔT _J I _{DSS}	Breakdown Voltage Temperature			-21		mV/°C
	Coefficient	I_D = -250µA, referenced to 25°C		-21		mV/°C
lass	Zero Gate Voltage Drain Current	$V_{DS} = -24V, V_{GS} = 0V$			1	μA
000	Gate to Source Leakage Current	V_{GS} = ±25V, V_{DS} = 0V			±10	μA
On Charac	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-2.1	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		6		mV/°C
5	- P	V _{GS} = -10V, I _D = -8.8A		16	20	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -4.5V, I_D = -6.7A$		26	35	mΩ
		V _{GS} = -10V, I _D = -8.8A, T _J = 125°C		22	28	1
9 _{FS}	Forward Transconductance	V _{DS} = -5V, I _D = -8.8A		24		S
Dynamic (Characteristics					
C _{iss}	Input Capacitance			1385	1845	pF
C _{oss}	Output Capacitance	$-V_{DS} = -15V, V_{GS} = 0V,$		275	365	pF
	Reverse Transfer Capacitance	f = 1MHz		230	345	pF
Crss						
R _g	Gate Resistance Characteristics	f = 1MHz		4.5		Ω
R _g Switching t _{d(on)} t _r	Characteristics Turn-On Delay Time Rise Time	f = 1MHz V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6	20 12	ns ns
Rg Switching t _{d(on)} t _r t _{d(off)}	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V _{DD} = -15V, I _D = -8.8A,		10 6 30	12 48	ns ns ns
R _g Switching t _{d(on)} t _r t _{d(off)} t _f	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6 30 12	12 48 22	ns ns ns ns
$\frac{R_g}{\textbf{Switching}}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ Q_g	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6 30 12 28	12 48 22 40	ns ns ns ns nC
$\begin{array}{c} & \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \end{array}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V _{DD} = -15V, I _D = -8.8A,		10 6 30 12 28 16	12 48 22	ns ns ns nC nC
Rg Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6 30 12 28 16 5.2	12 48 22 40	ns ns ns nC nC nC
$\frac{R_g}{switching}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_g}$ $\frac{Q_{gs}}{Q_{gd}}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6 30 12 28 16	12 48 22 40	ns ns ns nC nC
$\frac{R_g}{Switching}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_g}$ $\frac{Q_{gs}}{Q_{gd}}$ Drain-Sou	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -15V, I_{D} = -8.8A,$ $V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$ $V_{GS} = 0V \text{ to } -5V$ $V_{DD} = -15V,$ $I_{D} = -8.8A$		10 6 30 12 28 16 5.2	12 48 22 40	ns ns ns nC nC nC
$\frac{R_{g}}{Switching}$ $\frac{t_{d(on)}}{t_{r}}$ $\frac{t_{d(off)}}{d_{g}}$ $\frac{Q_{g}}{Q_{gs}}$ $\frac{Q_{gd}}{Q_{gd}}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge rce Diode Characteristics	V _{DD} = -15V, I _D = -8.8A, V _{GS} = -10V, R _{GEN} = 6Ω		10 6 30 12 28 16 5.2 7.4	12 48 22 40 23	ns ns ns nC nC nC

2. Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

4. Starting T_J = 25°C, L = 1mH, I_{AS} = -7A, V_{DD} = -30V, V_{GS} = -10V

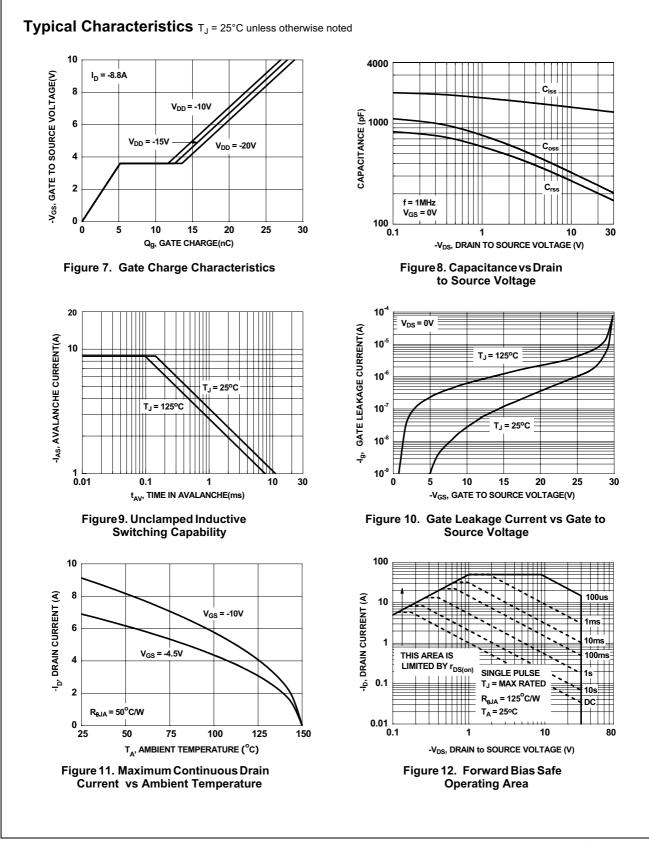
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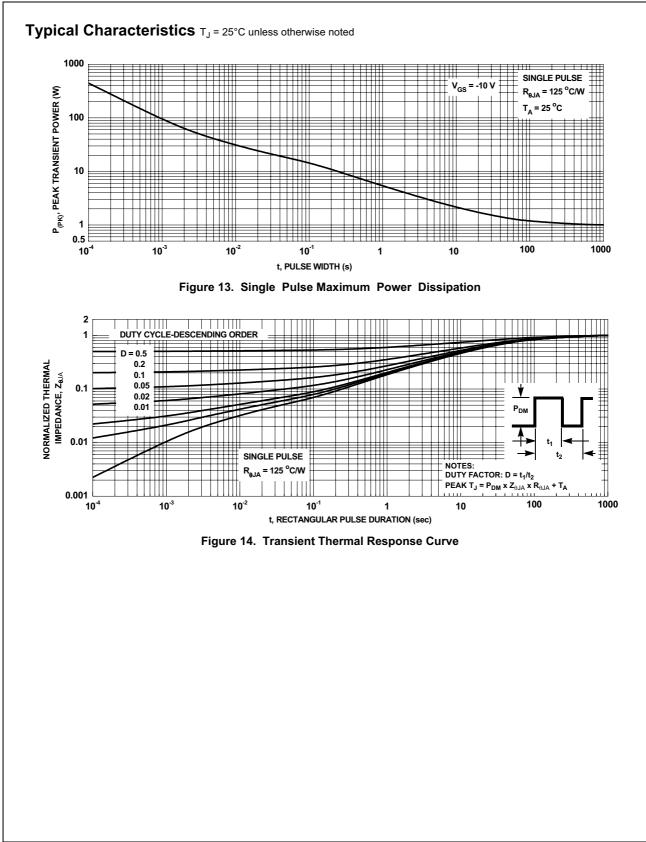
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